



Material Content Data Sheet



Sales Product Name		IPB60R380P6		Issued		19. July 2018		
MA#		MA001393614						
Package		PG-TO263-3-2		Weight*		1559.81 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.522	0.29	0.29	2899	2899
leadframe	non noble metal	iron	7439-89-6	0.304	0.02		195	
	inorganic material	phosphorus	7723-14-0	0.091	0.01		59	
	non noble metal	copper	7440-50-8	304.026	19.49	19.52	194913	195167
wire	non noble metal	aluminium	7429-90-5	7.171	0.46	0.46	4597	4597
encapsulation	organic material	carbon black	1333-86-4	10.224	0.66		6555	
	plastics	epoxy resin	-	112.466	7.21		72103	
	inorganic material	silicondioxide	60676-86-0	558.922	35.82	43.69	358327	436986
leadfinish	non noble metal	tin	7440-31-5	9.777	0.63	0.63	6268	6268
plating	non noble metal	nickel	7440-02-0	0.228	0.01		146	
	inorganic material	phosphorus	7723-14-0	0.001	0.00	0.01	1	146
solder	noble metal	silver	7440-22-4	0.092	0.01		59	
	non noble metal	tin	7440-31-5	0.074	0.00		47	
	non noble metal	lead	7439-92-1	3.529	0.23	0.24	2263	2369
heatspreader	non noble metal	iron	7439-89-6	0.548	0.04		352	
	inorganic material	phosphorus	7723-14-0	0.165	0.01		105	
	non noble metal	copper	7440-50-8	547.666	35.11	35.16	351111	351568
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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